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Applications of "<u>Embedded - Microcontrollers</u>"

Details	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	20MHz
Connectivity	I ² C, SPI
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	22
Program Memory Size	3.5KB (2K x 14)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	128 x 8
Voltage - Supply (Vcc/Vdd)	4V ~ 5.5V
Data Converters	-
Oscillator Type	External
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Through Hole
Package / Case	28-DIP (0.300", 7.62mm)
Supplier Device Package	28-SPDIP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16c62b-20i-sp

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

NOTES:

2.2 <u>Data Memory Organization</u>

The data memory is partitioned into multiple banks which contain the General Purpose Registers and the Special Function Registers. Bits RP1 and RP0 are the bank select bits.

RP1⁽¹⁾ RP0

(STATUS<6:5>)

- $= 00 \rightarrow Bank0$
- $= 01 \rightarrow Bank1$
- = 10 → Bank2 (not implemented)
- = $11 \rightarrow Bank3$ (not implemented)

Note 1: Maintain this bit clear to ensure upward compatibility with future products.

Each bank extends up to 7Fh (128 bytes). The lower locations of each bank are reserved for the Special Function Registers. Above the Special Function Registers are General Purpose Registers, implemented as static RAM. All implemented banks contain Special Function Registers. Some "high use" Special Function Registers from one bank may be mirrored in another bank for code reduction and guicker access.

2.2.1 GENERAL PURPOSE REGISTER FILE

The register file can be accessed either directly, or indirectly through the File Select Register FSR (Section 2.5).

FIGURE 2-2: REGISTER FILE MAP

File			File			
Address			Address			
00h	INDF ⁽¹⁾	INDF ⁽¹⁾	80h			
01h	TMR0	OPTION_REG	81h			
02h	PCL	PCL	82h			
03h	STATUS	STATUS	83h			
04h	FSR	FSR	84h			
05h	PORTA	TRISA	85h			
06h	PORTB	TRISB	86h			
07h	PORTC	TRISC	87h			
08h		_	88h			
09h	_	_	89h			
0Ah	PCLATH	PCLATH	8Ah			
0Bh	INTCON	INTCON	8Bh			
0Ch	PIR1	PIE1	8Ch			
0Dh	_	-	8Dh			
0Eh	TMR1L	PCON	8Eh			
0Fh	TMR1H	_	8Fh			
10h	T1CON	_	90h			
11h	TMR2	_	91h			
12h	T2CON	PR2	92h			
13h	SSPBUF	SSPADD	93h			
14h	SSPCON	SSPSTAT	94h			
15h	CCPR1L	_	95h			
16h	CCPR1H	_	96h			
17h	CCP1CON	_	97h			
18h	_	_	98h			
19h	_	_	99h			
1Ah	_	_	9Ah			
1Bh	_	_	9Bh			
1Ch	_	_	9Ch			
1Dh	_	_	9Dh			
1Eh	ADRES ⁽²⁾	_	9Eh			
1Fh	ADCON0 ⁽²⁾	ADCON1 ⁽²⁾	9Fh			
20h		General	A0h			
		Purpose				
	General	Registers	BFh			
	Purpose	_	C0h			
	Registers	_				
7Fh		_	FFh			
Į.	Bank 0	Bank 1	ļ			
Uni	implemented da	ata memory loca	tions,			
read	l as '0'.	•				
Note 1: No	lote 1: Not a physical register.					

Note 1: Not a physical register.

2: These registers are not implemented on the PIC16C62B, read as '0'.

2.2.2.3 INTCON REGISTER

The INTCON Register is a readable and writable register, which contains various interrupt enable and flag bits for the TMR0 register overflow, RB Port change and External RB0/INT pin interrupts.

Interrupt flag bits are set when an interrupt condition occurs, regardless of the state of its corresponding enable bit or the global enable bit, GIE (INTCON<7>). User software should ensure the appropriate interrupt flag bits are clear prior to enabling an interrupt.

REGISTER 2-3: INTCON REGISTER (ADDRESS 0Bh, 8Bh)

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-x	
GIE	PEIE	TOIE	INTE	RBIE	T0IF	INTF	RBIF	R = Readable bit W = Writable bit
bit7							bit0	- n = Value at POR reset
bit 7:	GIE: Glob 1 = Enabl 0 = Disab	es all un-r	nasked in					
bit 6:	PEIE : Per	ripheral Int	errupt En nasked pe	eripheral ir	nterrupts			
bit 5:	T0IE : TMI 1 = Enabl 0 = Disab		R0 interru	ıpt	bit			
bit 4:		es the RB	0/INT exte	rrupt Enat ernal inter ernal inter	rupt			
bit 3:		es the RB	port char	upt Enable nge interru nge interru	pt			
bit 2:	TOIF : TMI 1 = TMRO 0 = TMRO	register h	nas overflo	owed (soft	ware must o	clear bit)		
bit 1:		RB0/INT ex	cternal into		urred (softw	are must o	clear bit)	
bit 0:		st one of t	he RB7:R	B4 input p			ite (clear by	reading PORTB)

Note:

TABLE 3-1 PORTA FUNCTIONS

Name	Bit#	Buffer	Function
RA0/AN0	bit0	TTL	Input/output or analog input(1)
RA1/AN1	bit1	TTL	Input/output or analog input(1)
RA2/AN2	bit2	TTL	Input/output or analog input(1)
RA3/AN3/VREF	bit3	TTL	Input/output or analog input ⁽¹⁾ or VREF ⁽¹⁾
RA4/T0CKI	bit4	ST	Input/output or external clock input for Timer0 Output is open drain type
RA5/SS/AN4	bit5	TTL	Input/output or slave select input for synchronous serial port or analog input ⁽¹⁾

Legend: TTL = TTL input, ST = Schmitt Trigger input

Note 1: The PIC16C62B does not implement the A/D module.

TABLE 3-2 SUMMARY OF REGISTERS ASSOCIATED WITH PORTA

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Value on all other resets
05h	PORTA (for PIC16C72A only)	_	_	RA5	RA4	RA3	RA2	RA1	RA0	0x 0000	0u 0000
05h	PORTA (for PIC16C62B only)	_	_	RA5	RA4	RA3	RA2	RA1	RA0	xx xxxx	uu uuuu
85h	TRISA	_	_	PORTA	Data D	irection	Register			11 1111	11 1111
9Fh	ADCON1 ⁽¹⁾	_	_	_	_	_	PCFG2	PCFG1	PCFG0	000	000

Legend: x = unknown, u = unchanged, - = unimplemented locations read as '0'. Shaded cells are not used by PORTA.**Note 1:**The PIC16C62B does not implement the A/D module. Maintain this register clear.

TABLE 3-5 PORTC FUNCTIONS

Name	Bit#	Buffer Type	Function	TRISC Override
RC0/T1OSO/T1CKI	bit0	ST	Input/output port pin or Timer1 oscillator output/Timer1 clock input	Yes
RC1/T1OSI	bit1	ST	Input/output port pin or Timer1 oscillator input	Yes
RC2/CCP1	bit2	ST	Input/output port pin or Capture1 input/Compare1 output/PWM1 output	No
RC3/SCK/SCL	bit3	ST	RC3 can also be the synchronous serial clock for both SPI and I ² C modes.	No
RC4/SDI/SDA	bit4	ST	RC4 can also be the SPI Data In (SPI mode) or data I/O (I ² C mode).	No
RC5/SDO	bit5	ST	Input/output port pin or Synchronous Serial Port data output	No
RC6	bit6	ST	Input/output port pin	No
RC7	bit7	ST	Input/output port pin	No

Legend: ST = Schmitt Trigger input

TABLE 3-6 SUMMARY OF REGISTERS ASSOCIATED WITH PORTC

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other resets
07h	PORTC	RC7	RC7 RC6 RC5 RC4 RC3 RC2 RC1 RC0						RC0	xxxx xxxx	uuuu uuuu
87h	TRISC	PORTC I	PORTC Data Direction Register							1111 1111	1111 1111

Legend: x = unknown, u = unchanged.

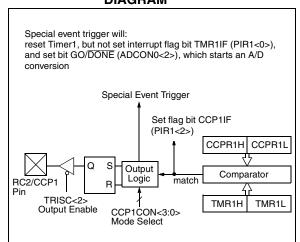
7.2 Compare Mode

In Compare mode, the 16-bit CCPR1 register value is constantly compared against the TMR1 register pair value. When a match occurs, the RC2/CCP1 pin is:

- · driven High
- · driven Low
- · remains Unchanged

The action on the pin is based on the value of control bits CCP1M3:CCP1M0 (CCP1CON<3:0>). The interrupt flag bit, CCP1IF, is set on all compare matches.

FIGURE 7-2: COMPARE MODE OPERATION BLOCK DIAGRAM



7.2.1 CCP PIN CONFIGURATION

The user must configure the RC2/CCP1 pin as an output by clearing the TRISC<2> bit.

Note: Clearing the CCP1CON register will force the RC2/CCP1 compare output latch to the default low level. This is not the data latch.

7.2.2 TIMER1 MODE SELECTION

Timer1 must be running in Timer mode or Synchronized Counter mode if the CCP module is using the compare feature. In Asynchronous Counter mode, the compare operation may not work.

7.2.3 SOFTWARE INTERRUPT MODE

When a generated software interrupt is chosen, the CCP1 pin is not affected. Only a CCP interrupt is generated (if enabled).

7.2.4 SPECIAL EVENT TRIGGER

In this mode, an internal hardware trigger is generated, which may be used to initiate an action.

The special event trigger output of CCP1 resets the TMR1 register pair. This allows the CCPR1 register to effectively be a 16-bit programmable period register for Timer1.

The special trigger output of CCP1 resets the TMR1 register pair and starts an A/D conversion (if the A/D module is enabled).

TABLE 7-3 REGISTERS ASSOCIATED WITH CAPTURE, COMPARE, AND TIMER1

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Value on all other resets
0Bh,8Bh	INTCON	GIE	PEIE	TOIE	INTE	RBIE	TOIF	INTF	RBIF	0000 000x	0000 000u
0Ch	PIR1	_	ADIF	_	_	SSPIF	CCP1IF	TMR2IF	TMR1IF	-0 0000	-0 0000
8Ch	PIE1	_	ADIE	_	_	SSPIE	CCP1IE	TMR2IE	TMR1IE	-0 0000	-0 0000
87h	TRISC	PORTC Da	ata Dire	ection Regis	ter					1111 1111	1111 1111
0Eh	TMR1L	Holding reg	gister fo	or the Least	Significant	Byte of the	16-bit TMF	R1 register		xxxx xxxx	uuuu uuuu
0Fh	TMR1H	Holding reg	gister fo	or the Most	Significant	Byte of the 1	16-bit TMR	1register		xxxx xxxx	uuuu uuuu
10h	T1CON	_	_	T1CKPS1	T1CKPS0	T10SCEN	T1SYNC	TMR1CS	TMR10N	00 0000	uu uuuu
15h	CCPR1L	Capture/Compare/PWM register1 (LSB)							xxxx xxxx	uuuu uuuu	
16h	CCPR1H	Capture/Compare/PWM register1 (MSB)						xxxx xxxx	uuuu uuuu		
17h	CCP1CON	_	_	CCP1X	CCP1Y	CCP1M3	CCP1M2	CCP1M1	CCP1M0	00 0000	00 0000

Legend: x = unknown, u = unchanged, - = unimplemented read as '0'. Shaded cells are not used by Capture and Timer1.

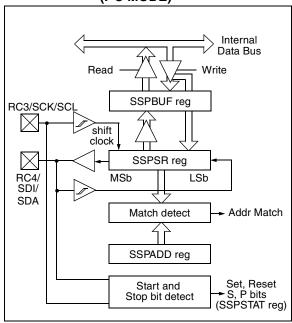
8.3 SSP I²C Operation

The SSP module in I²C mode fully implements all slave functions, except general call support, and provides interrupts on start and stop bits in hardware to support firmware implementations of the master functions. The SSP module implements the standard mode specifications, as well as 7-bit and 10-bit addressing.

Two pins are used for data transfer. These are the RC3/SCK/SCL pin, which is the clock (SCL), and the RC4/SDI/SDA pin, which is the data (SDA). The user must configure these pins as inputs or outputs through the TRISC<4:3> bits.

The SSP module functions are enabled by setting SSP Enable bit SSPEN (SSPCON<5>).

FIGURE 8-2: SSP BLOCK DIAGRAM (I²C MODE)



The SSP module has five registers for I^2C operation. These are the:

- SSP Control Register (SSPCON)
- SSP Status Register (SSPSTAT)
- Serial Receive/Transmit Buffer (SSPBUF)
- SSP Shift Register (SSPSR) Not accessible
- SSP Address Register (SSPADD)

The SSPCON register allows control of the I²C operation. Four mode selection bits (SSPCON<3:0>) allow one of the following I²C modes to be selected:

- I²C Slave mode (7-bit address)
- I²C Slave mode (10-bit address)
- I²C Slave mode (7-bit address), with start and stop bit interrupts enabled for firmware master mode support
- I²C Slave mode (10-bit address), with start and stop bit interrupts enabled for firmware master mode support
- I²C start and stop bit interrupts enabled for firmware master mode support, slave mode idle

Selection of any I²C mode, with the SSPEN bit set, forces the SCL and SDA pins to be operated as open drain outputs, provided these pins are programmed to inputs by setting the appropriate TRISC bits.

Additional information on SSP I^2C operation may be found in the $PIC^{\textcircled{\tiny{B}}}$ MCU Mid-Range Reference Manual, (DS33023).

8.3.1 SLAVE MODE

In slave mode, the SCL and SDA pins must be configured as inputs (TRISC<4:3> set). The SSP module will override the input state with the output data when required (slave-transmitter).

When an address is matched or the data transfer after an address match is received, the hardware automatically will generate the acknowledge (\overline{ACK}) pulse, and load the SSPBUF register with the received value in the SSPSR register.

There are certain conditions that will cause the SSP module not to give this \overline{ACK} pulse. This happens if either of the following conditions occur:

- a) The buffer full bit BF (SSPSTAT<0>) was set before the transfer was completed.
- b) The overflow bit SSPOV (SSPCON<6>) was set before the transfer was completed.

In this case, the SSPSR register value is not loaded into the SSPBUF, but bit SSPIF (PIR1<3>) is set. Table 8-2 shows what happens when a data transfer byte is received, given the status of bits BF and SSPOV. The shaded cells show the condition where user software did not properly clear the overflow condition. Flag bit BF is cleared by reading the SSPBUF register, while bit SSPOV is cleared through software.

The SCL clock input must have a minimum high and low for proper operation. The high and low times of the I²C specification, as well as the requirement of the SSP module, is shown in timing parameter #100, THIGH, and parameter #101, TLOW.

REGISTER 8-2: SSPCON: SYNC SERIAL PORT CONTROL REGISTER (ADDRESS 14h)

R/W-0 R/W-0 R/W-0 R/W-0 R/W-0 R/W-0 R/W-0 R/W-0 SSPOV CKP SSPM1 SSPM0 WCOL **SSPEN** SSPM3 SSPM2 bit7 bit0

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

- n =Value at POR reset

bit 7: WCOL: Write Collision Detect bit

1 = The SSPBUF register is written while it is still transmitting the previous word (must be cleared in software)

0 = No collision

bit 6: SSPOV: Receive Overflow Indicator bit

In SPI mode

1 = A new byte is received while the SSPBUF register is still holding the previous data. In case of overflow, the data in SSPSR is lost. Overflow can only occur in slave mode. The user must read the SSPBUF, even if only transmitting data, to avoid setting overflow. In master operation, the overflow bit is not set since each new reception (and transmission) is initiated by writing to the SSPBUF register.

0 = No overflow

In I²C mode

- 1 = A byte is received while the SSPBUF register is still holding the previous byte. SSPOV is a "don't care" in transmit mode. SSPOV must be cleared in software in either mode.
- 0 = No overflow
- bit 5: SSPEN: Synchronous Serial Port Enable bit

In SPI mode

- 1 = Enables serial port and configures SCK, SDO, and SDI as serial port pins
- 0 = Disables serial port and configures these pins as I/O port pins

In I²C mode

- 1 = Enables the serial port and configures the SDA and SCL pins as serial port pins
- 0 = Disables serial port and configures these pins as I/O port pins

In both modes, when enabled, these pins must be properly configured as input or output.

bit 4: CKP: Clock Polarity Select bit

In SPI mode

- 1 = Idle state for clock is a high level
- 0 = Idle state for clock is a low level

In I²C mode

SCK release control

- 1 = Enable clock
- 0 = Holds clock low (clock stretch)
- bit 3-0: SSPM3:SSPM0: Synchronous Serial Port Mode Select bits
 - 0000 = SPI master operation, clock = Fosc/4
 - 0001 = SPI master operation, clock = Fosc/16
 - 0010 = SPI master operation, clock = Fosc/64
 - 0011 = SPI master operation, clock = TMR2 output/2
 - 0100 = SPI slave mode, clock = SCK pin. \overline{SS} pin control enabled.
 - 0101 = SPI slave mode, clock = SCK pin. \overline{SS} pin control disabled. \overline{SS} can be used as I/O pin
 - $0110 = I^2C$ slave mode, 7-bit address
 - $0111 = I^2C$ slave mode, 10-bit address
 - $1011 = I^2C$ firmware controlled master operation (slave idle)
 - $1110 = I^2C$ slave mode, 7-bit address with start and stop bit interrupts enabled
 - $1111 = I^2C$ slave mode, 10-bit address with start and stop bit interrupts enabled

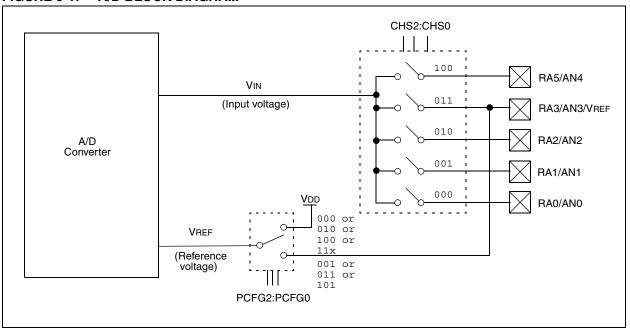
When the A/D conversion is complete, the result is loaded into the ADRES register, the GO/DONE bit, ADCON0<2>, is cleared, and the A/D interrupt flag bit, ADIF, is set. The block diagram of the A/D module is shown in Figure 9-1.

The value that is in the ADRES register is not modified for a Power-on Reset. The ADRES register will contain unknown data after a Power-on Reset.

After the A/D module has been configured as desired, the selected channel must be acquired before the conversion is started. The analog input channels must have their corresponding TRIS bits selected as an input. To determine acquisition time, see Section 9.1. After this acquisition time has elapsed, the A/D conversion can be started. The following steps should be followed for doing an A/D conversion:

- 1. Configure the A/D module:
 - Configure analog pins / voltage reference / and digital I/O (ADCON1)
 - Select A/D input channel (ADCON0)
 - Select A/D conversion clock (ADCON0)
 - Turn on A/D module (ADCON0)
- 2. Configure A/D interrupt (if desired):
 - · Clear ADIF bit
 - · Set ADIE bit
 - · Set GIE bit
- 3. Wait the required acquisition time.
- 4. Start conversion:
 - Set GO/DONE bit (ADCON0)
- 5. Wait for A/D conversion to complete, by either:
 - Polling for the GO/DONE bit to be cleared OR
 - · Waiting for the A/D interrupt
- Read A/D Result register (ADRES), clear bit ADIF if required.
- 7. For next conversion, go to step 1 or step 2 as required. The A/D conversion time per bit is defined as TAD. A minimum wait of 2TAD is required before next acquisition starts.

FIGURE 9-1: A/D BLOCK DIAGRAM



9.2 <u>Selecting the A/D Conversion Clock</u>

The A/D conversion time per bit is defined as TAD. The A/D conversion requires 9.5TAD per 8-bit conversion. The source of the A/D conversion clock is software selectable. The four possible options for TAD are:

- 2Tosc
- 8Tosc
- 32Tosc
- · Internal RC oscillator

For correct A/D conversions, the A/D conversion clock (TAD) must be selected to ensure a minimum TAD time of 1.6 $\mu s.$

The A/D module can operate during sleep mode, but the RC oscillator must be selected as the A/D clock source prior to the SLEEP instruction.

Table 9-1 shows the resultant TAD times derived from the device operating frequencies and the A/D clock source selected.

9.3 Configuring Analog Port Pins

The ADCON1 and TRISA registers control the operation of the A/D port pins. The port pins that are desired as analog inputs must have their corresponding TRIS bits set (input). If the TRIS bit is cleared (output), the digital output level (VOH or VOL) will be converted.

The A/D operation is independent of the state of the CHS2:CHS0 bits and the TRIS bits.

- Note 1: When reading the port register, all pins configured as analog input channels will read as cleared (a low level). Pins configured as digital inputs, will convert an analog input. Analog levels on a digitally configured input will not affect the conversion accuracy.
- Note 2: Analog levels on any pin that is defined as a digital input (including the AN4:AN0 pins) may cause the input buffer to consume current that is out of the devices specification.

TABLE 9-1 TAD vs. DEVICE OPERATING FREQUENCIES

AD Cloc	k Source (TAD)	Device Frequency						
Operation	ADCS1:ADCS0	20 MHz	5 MHz	1.25 MHz	333.33 kHz			
2Tosc	00	100 ns ⁽²⁾	400 ns ⁽²⁾	1.6 μs	6 μs			
8Tosc	01	400 ns ⁽²⁾	1.6 μs	6.4 μs	24 μs ⁽³⁾			
32Tosc	10	1.6 μs	6.4 μs	25.6 μs ⁽³⁾	96 μs ⁽³⁾			
RC ⁽⁵⁾	11	2 - 6 μs ^(1,4)	2 - 6 μs ^(1,4)	2 - 6 μs ^(1,4)	2 - 6 μs ⁽¹⁾			

Legend: Shaded cells are outside of recommended range.

- Note 1: The RC source has a typical TAD time of 4 μs .
 - 2: These values violate the minimum required TAD time.
 - **3:** For faster conversion times, the selection of another clock source is recommended.
 - 4: When device frequency is greater than 1 MHz, the RC A/D conversion clock source is recommended for sleep operation only.
 - 5: For extended voltage devices (LC), please refer to Electrical Specifications section.

BTFSS	Bit Test f, Skip if Set	CLRF	Clear f	
Syntax:	[label] BTFSS f,b	Syntax:	[label] CLRF f	
Operands:	$0 \leq f \leq 127$	Operands:	$0 \leq f \leq 127$	
	0 ≤ b < 7	Operation:	$00h \rightarrow (f)$	
Operation:	skip if $(f < b >) = 1$	·	$1 \rightarrow Z$	
Status Affected:	None	Status Affected:	Z	
Description:	If bit 'b' in register 'f' is '0', then the next instruction is executed. If bit 'b' is '1', then the next instruction is discarded and a NOP is executed instead, making this a 2TCY instruction.	Description:	The contents of register 'f' are cleared and the Z bit is set.	

BTFSC	Bit Test, Skip if Clear	CLRW	Clear W
Syntax:	[label] BTFSC f,b	Syntax:	[label] CLRW
Operands:	$0 \le f \le 127$	Operands:	None
	$0 \le b \le 7$	Operation:	$00h \rightarrow (W)$
Operation:	skip if $(f < b >) = 0$		$1 \rightarrow Z$
Status Affected:	None	Status Affected:	Z
Description:	If bit 'b' in register 'f' is '1', then the next instruction is executed. If bit 'b' in register 'f' is '0', then the next instruction is discarded, and a \mathtt{NOP} is executed instead, making this a 2Tcy instruction.	Description:	W register is cleared. Zero bit (Z) is set.

CALL	Call Subroutine	CLRWDT	Clear Watchdog Timer
Syntax:	[label] CALL k	Syntax:	[label] CLRWDT
Operands:	$0 \leq k \leq 2047$	Operands:	None
Operation:	$(PC)+ 1 \rightarrow TOS,$ $k \rightarrow PC<10:0>,$ $(PCLATH<4:3>) \rightarrow PC<12:11>$	Operation:	00h → WDT 0 → WDT prescaler, 1 → $\overline{10}$
Status Affected:	None		$1 \rightarrow \overline{PD}$
Description:	Call Subroutine. First, return address	Status Affected:	TO, PD
	(PC+1) is pushed onto the stack. The eleven bit immediate address is loaded into PC bits <10:0>. The upper bits of the PC are loaded from PCLATH. CALL is a two cycle instruction.	Description:	CLRWDT instruction resets the Watchdog Timer. It also resets the prescaler of the WDT. Status bits TO and PD are set.

SUBLW	Subtract W from Literal	XORLW	Exclusive OR Literal with W
Syntax:	[label] SUBLW k	Syntax:	[label] XORLW k
Operands:	$0 \leq k \leq 255$	Operands:	$0 \le k \le 255$
Operation:	$k - (W) \rightarrow (W)$	Operation:	(W) .XOR. $k \rightarrow (W)$
Status Affected:	C, DC, Z	Status Affected:	Z
Description:	The W register is subtracted (2's complement method) from the eight bit literal 'k'. The result is placed in the W register.	Description:	The contents of the W register are XOR'ed with the eight bit literal 'k'. The result is placed in the W register.

SUBWF	Subtract W from f
Syntax:	[label] SUBWF f,d
Operands:	$0 \le f \le 127$ $d \in [0,1]$
Operation:	(f) - (W) \rightarrow (destination)
Status Affected:	C, DC, Z
Description:	Subtract (2's complement method) W register from register 'f'. If 'd' is 0, the result is stored in the W register. If 'd' is 1, the result is stored back in register 'f'.

XORWF	Exclusive OR W with f
Syntax:	[<i>label</i>] XORWF f,d
Operands:	$0 \le f \le 127$ $d \in [0,1]$
Operation:	(W) .XOR. (f) \rightarrow (destination)
Status Affected:	Z
Description:	Exclusive OR the contents of the W register with register 'f'. If 'd' is 0, the result is stored in the W register. If 'd' is 1, the result is stored back in register 'f'.

[label] SWAPF f,d
$0 \le f \le 127$ $d \in [0,1]$
$(f<3:0>) \rightarrow (destination<7:4>),$ $(f<7:4>) \rightarrow (destination<3:0>)$
None
The upper and lower nibbles of register 'f' are exchanged. If 'd' is 0, the result is placed in W register. If 'd' is 1, the result is placed in register 'f'.

FIGURE 13-7: RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER AND POWER-UP TIMER TIMING

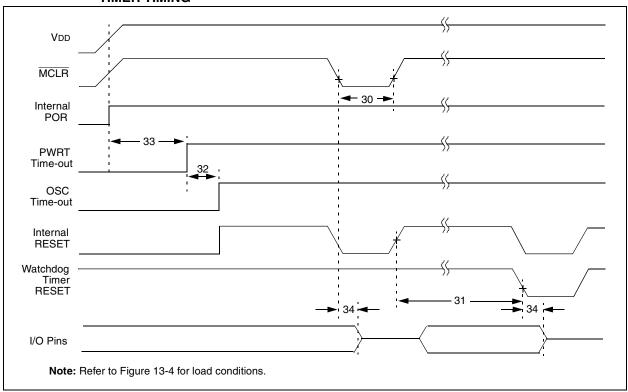


FIGURE 13-8: BROWN-OUT RESET TIMING



TABLE 13-4: RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER, POWER-UP TIMER AND BROWN-OUT RESET REQUIREMENTS

Param No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
30	TmcL	MCLR Pulse Width (low)	2	_	_	μS	VDD = 5V, -40°C to +125°C
31*	Twdt	Watchdog Timer Time-out Period (No Prescaler)	7	18	33	ms	VDD = 5V, -40°C to +125°C
32	Tost	Oscillator Start-up Timer Period	_	1024 Tosc	_	_	Tosc = OSC1 period
33*	Tpwrt	Power-up Timer Period	28	72	132	ms	$VDD = 5V, -40^{\circ}C \text{ to } +125^{\circ}C$
34	Tıoz	I/O Hi-impedance from MCLR Low or WDT reset	_	_	2.1	μS	
35	Твоп	Brown-out Reset Pulse Width	100	_	_	μS	VDD ≤ BVDD (D005)

^{*} These parameters are characterized but not tested.

[†] Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

FIGURE 13-10: CAPTURE/COMPARE/PWM TIMINGS

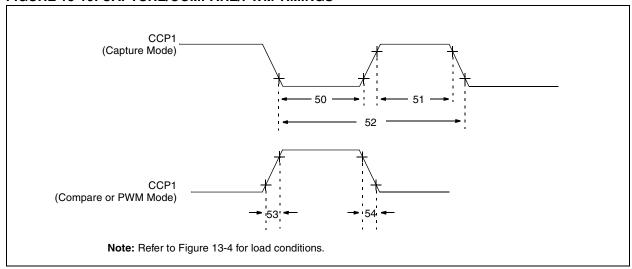


TABLE 13-6: CAPTURE/COMPARE/PWM REQUIREMENTS

Param No.	Sym		Characteristi	С	Min	Тур†	Max	Units	Conditions
50*	TccL	CCP1 input low	No Prescaler		0.5Tcy + 20	_	_	ns	
		time	With Prescaler	PIC16CXX	10	_	_	ns	
				PIC16LCXX	20	_	_	ns	
51*	TccH	cH CCP1 input high time	No Prescaler		0.5Tcy + 20	_	_	ns	
			With Prescaler	PIC16CXX	10	_	_	ns	
				PIC16LCXX	20	_	_	ns	
52*	TccP	CCP1 input period			3Tcy + 40 N	_	_	ns	N = prescale value (1,4, or 16)
53*	TccR	CCP1 output rise	time	PIC16CXX	_	10	25	ns	
				PIC16LCXX	_	25	45	ns	
54*	TccF	CCP1 output fall t	time	PIC16CXX	_	10	25	ns	
				PIC16LCXX	_	25	45	ns	

^{*} These parameters are characterized but not tested.

[†] Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

FIGURE 13-15: I²C BUS START/STOP BITS TIMING

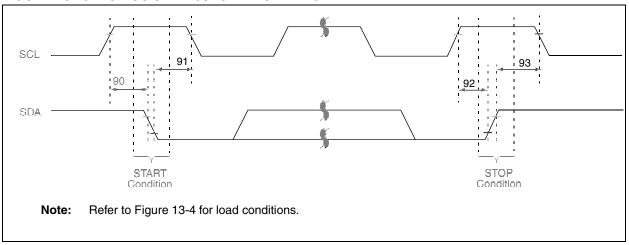


TABLE 13-11: I²C BUS START/STOP BITS REQUIREMENTS

Parameter	Sym	Charac	Characteristic		Ту	Max	Unit	Conditions
No.				р		S		
90*	TSU:STA	START condition	100 kHz mode	4700	_	_	ns	Only relevant for repeated
		Setup time	400 kHz mode	600	_	_		START condition
91*	THD:STA	START condition	100 kHz mode	4000	_	_	ns	After this period the first clock
		Hold time	400 kHz mode	600	_	_		pulse is generated
92*	Tsu:sto	STOP condition	100 kHz mode	4700	_	_	ns	
		Setup time	400 kHz mode	600	_	_		
93	THD:STO	STOP condition	100 kHz mode	4000	_	_	ns	
		Hold time	400 kHz mode	600	_	_		

^{*} These parameters are characterized but not tested.

TABLE 13-13: A/D CONVERTER CHARACTERISTICS:

PIC16C72A-04 (COMMERCIAL, INDUSTRIAL, EXTENDED) PIC16C72A-20 (COMMERCIAL, INDUSTRIAL, EXTENDED) PIC16LC72A-04 (COMMERCIAL, INDUSTRIAL)

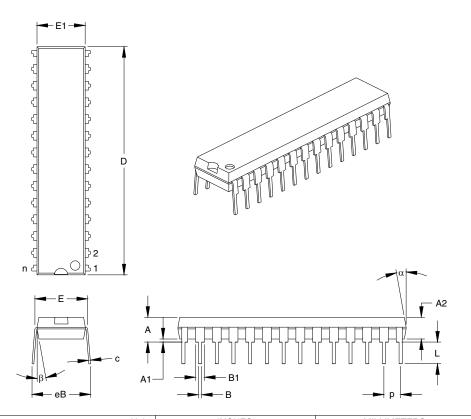
Param No.	Sym	Characte	ristic	Min	Тур†	Max	Units	Conditions
A01	NR	Resolution			_	8-bits	bit	$VREF = VDD = 5.12V$, $VSS \le VAIN \le VREF$
A02	Eabs	Total Absolute error		_	_	< ± 1	LSB	$VREF = VDD = 5.12V$, $VSS \le VAIN \le VREF$
A03	EIL	Integral linearity error	_	_	< ± 1	LSB	$\begin{aligned} & \text{VREF} = \text{VDD} = 5.12\text{V}, \\ & \text{VSS} \leq \text{VAIN} \leq \text{VREF} \end{aligned}$	
A04	EDL	Differential linearity e	_	_	< ± 1	LSB	$\begin{aligned} & \text{VREF} = \text{VDD} = 5.12\text{V}, \\ & \text{VSS} \leq \text{VAIN} \leq \text{VREF} \end{aligned}$	
A05	EFS	Full scale error		_	< ± 1	LSB	$\begin{aligned} & \text{VREF} = \text{VDD} = 5.12\text{V}, \\ & \text{VSS} \leq \text{VAIN} \leq \text{VREF} \end{aligned}$	
A06	Eoff	Offset error		_	_	< ± 1	LSB	$\begin{aligned} & \text{VREF} = \text{VDD} = 5.12\text{V}, \\ & \text{VSS} \leq \text{VAIN} \leq \text{VREF} \end{aligned}$
A10	_	Monotonicity		_	guaranteed (Note 3)	_	_	$Vss \leq Vain \leq Vref$
A20	VREF	Reference voltage		2.5V	_	VDD + 0.3	V	
A25	VAIN	Analog input voltage		Vss - 0.3	_	VREF + 0.3	V	
A30	ZAIN	Recommended impe analog voltage sourc		_	_	10.0	kΩ	
A40	IAD	A/D conversion	PIC16CXX	_	180	_	μΑ	Average current con-
		current (VDD)	PIC16LCXX	_	90	ı	μΑ	sumption when A/D is on. (Note 1)
A50	IREF	VREF input current (N	VREF input current (Note 2)		_	1000	μА	During VAIN acquisition. Based on differential of VHOLD to VAIN to charge CHOLD, see
				_	_	10	μΑ	Section 9.1. During A/D conversion cycle

^{*} These parameters are characterized but not tested.

- **Note 1:** When A/D is off, it will not consume any current other than minor leakage current. The power-down current spec includes any such leakage from the A/D module.
 - 2: VREF current is from RA3 pin or VDD pin, whichever is selected as reference input.
 - 3: The A/D conversion result never decreases with an increase in the Input Voltage and has no missing codes.

[†] Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

28-Lead Skinny Plastic Dual In-line (SP) – 300 mil (PDIP) 15.2



	Units		INCHES*		MILLIMETERS		
Dimension	n Limits	MIN	NOM	MAX	MIN	NOM	MAX
Number of Pins	n		28			28	
Pitch	р		.100			2.54	
Top to Seating Plane	Α	.140	.150	.160	3.56	3.81	4.06
Molded Package Thickness	A2	.125	.130	.135	3.18	3.30	3.43
Base to Seating Plane	A1	.015			0.38		
Shoulder to Shoulder Width	Е	.300	.313	.325	7.62	7.94	8.26
Molded Package Width	E1	.279	.307	.335	7.09	7.80	8.51
Overall Length	D	1.345	1.365	1.385	34.16	34.67	35.18
Tip to Seating Plane	L	.125	.130	.135	3.18	3.30	3.43
Lead Thickness	С	.008	.012	.015	0.20	0.29	0.38
Upper Lead Width	B1	.040	.053	.065	1.02	1.33	1.65
Lower Lead Width	В	.016	.019	.022	0.41	0.48	0.56
Overall Row Spacing	eB	.320	.350	.430	8.13	8.89	10.92
Mold Draft Angle Top	α	5	10	15	5	10	15
Mold Draft Angle Bottom	β	5	10	15	5	10	15

^{*}Controlling Parameter

Notes:
Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" (0.254mm) per side.

JEDEC Equivalent: MO-095
Drawing No. C04-070

APPENDIX C: MIGRATION FROM BASE-LINE TO MID-RANGE DEVICES

This section discusses how to migrate from a baseline device (i.e., PIC16C5X) to a mid-range device (i.e., PIC16CXXX).

The following are the list of modifications over the PIC16C5X microcontroller family:

- Instruction word length is increased to 14-bits.
 This allows larger page sizes both in program
 memory (2K now as opposed to 512 before) and
 register file (128 bytes now versus 32 bytes
 before).
- A PC high latch register (PCLATH) is added to handle program memory paging. Bits PA2, PA1, PA0 are removed from STATUS register.
- 3. Data memory paging is redefined slightly. STATUS register is modified.
- Four new instructions have been added: RETURN, RETFIE, ADDLW, and SUBLW.

 Two instructions TRIS and OPTION are being phased out although they are kept for compati-bility with PIC16C5X.
- OPTION_REG and TRIS registers are made addressable.
- Interrupt capability is added. Interrupt vector is at 0004h.
- 7. Stack size is increased to 8 deep.
- 8. Reset vector is changed to 0000h.
- Reset of all registers is revisited. Five different reset (and wake-up) types are recognized. Registers are reset differently.
- Wake up from SLEEP through interrupt is added.

- Two separate timers, Oscillator Start-up Timer (OST) and Power-up Timer (PWRT) are included for more reliable power-up. These timers are invoked selectively to avoid unnecessary delays on power-up and wake-up.
- 12. PORTB has weak pull-ups and interrupt on change feature.
- 13. T0CKI pin is also a port pin (RA4) now.
- 14. FSR is made a full eight bit register.
- 15. "In-circuit serial programming" is made possible. The user can program PIC16CXX devices using only five pins: VDD, Vss, MCLR/VPP, RB6 (clock) and RB7 (data in/out).
- 16. PCON status register is added with a Power-on Reset status bit (POR).
- 17. Code protection scheme is enhanced such that portions of the program memory can be protected, while the remainder is unprotected.
- Brown-out protection circuitry has been added. Controlled by configuration word bit BODEN. Brown-out reset ensures the device is placed in a reset condition if VDD dips below a fixed setpoint.

To convert code written for PIC16C5X to PIC16CXXX, the user should take the following steps:

- 1. Remove any program memory page select operations (PA2, PA1, PA0 bits) for CALL, GOTO.
- Revisit any computed jump operations (write to PC or add to PC, etc.) to make sure page bits are set properly under the new scheme.
- 3. Eliminate any data memory page switching. Redefine data variables to reallocate them.
- 4. Verify all writes to STATUS, OPTION, and FSR registers since these have changed.
- 5. Change reset vector to 0000h.

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